



# Product Change Notification

**Change Notification #:** 117309 - 00  
**Change Title:** Intel® RAID Controller RS3DC040  
Intel® RAID Controller RS3DC080  
PCN 117309-00, Product Design,  
Connector Removal  
**Date of Publication:** December 4, 2019

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

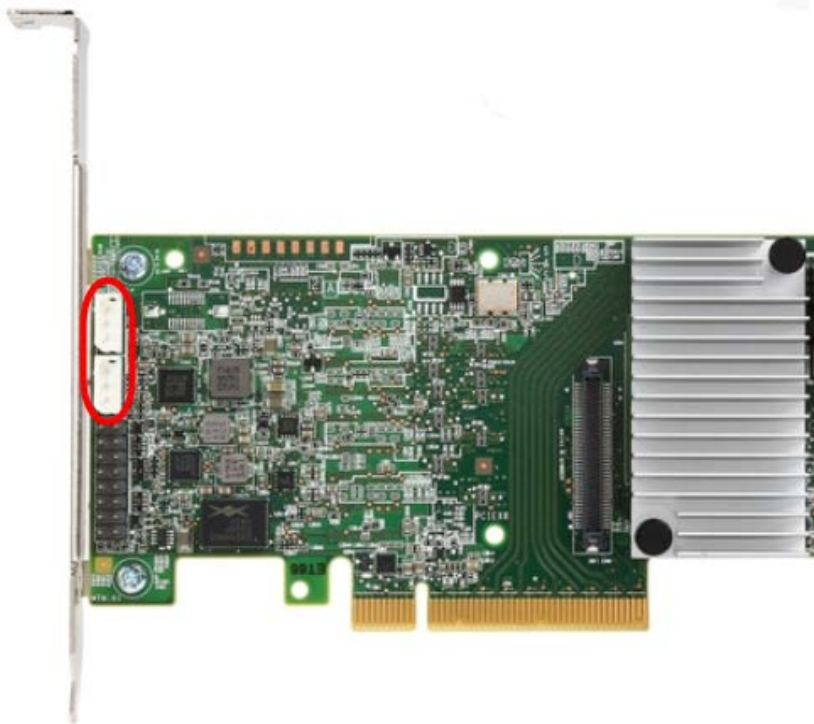
<b>Date Customer Must be Ready to Receive Post-Conversion Material:*</b>	December 19, 2019
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is implementing the following change on the Intel® RAID Controller RS3DC040 and the Intel® RAID Controller RS3DC080:

Remove the J1A2 and J1A4 connectors due to these connectors going end of life. The connectors were originally intended for the SCSI Enclosure Services (SES) over I2C signals which are not used when the cards are installed on an Intel® Server System. See figure 1 on the next page for identification.



**Figure1.** Connectors J1A2 and J1A4 are circled in red

**Customer Impact of Change and Recommended Action:**

Intel does not expect any impact to customers from this change if the cards are installed on an Intel® chassis. If the cards are installed on a system other than Intel®, customers must evaluate if the SES over I2C cables are used, in that case the new cards cannot be used.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
RS3DC080	934643	G98362-003	G98401-251	G98362-004	G98401-252
RS3DC040	934644	G98384-003	G98415-251	G98384-004	G98415-252

**PCN Revision History:**

**Date of Revision:**  
December 4, 2019

**Revision Number:**  
00

**Reason:**  
Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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